

REMARKS

The Examiner has rejected claims 1-5 and 7-11 under 35 USC §112, second paragraph on the grounds that it is unclear how the first composition is a liquid and cured. Claim 1, directed to a silicon wafer having an underfill composition comprising two composition parts on one face, has been amended to recite that the first composition on the silicon wafer is cured. Claim 7, directed to the composition itself, is claimed in an uncured state. Applicants believe the §112 rejection is overcome and request the Examiner to remove the rejection on these grounds.

The Examiner indicated that claims 6 and 12 would be allowable if the §112 rejection was overcome and if the claims were rewritten to include all the limitations of the base claim and intervening claims. Claims 1 and 7 have been amended to include the limitations of claims 2 to 6 and 8 to 12, respectively.

Applicants believe the case is now in condition for allowance and respectfully request the Examiner to so grant.

end of remarks